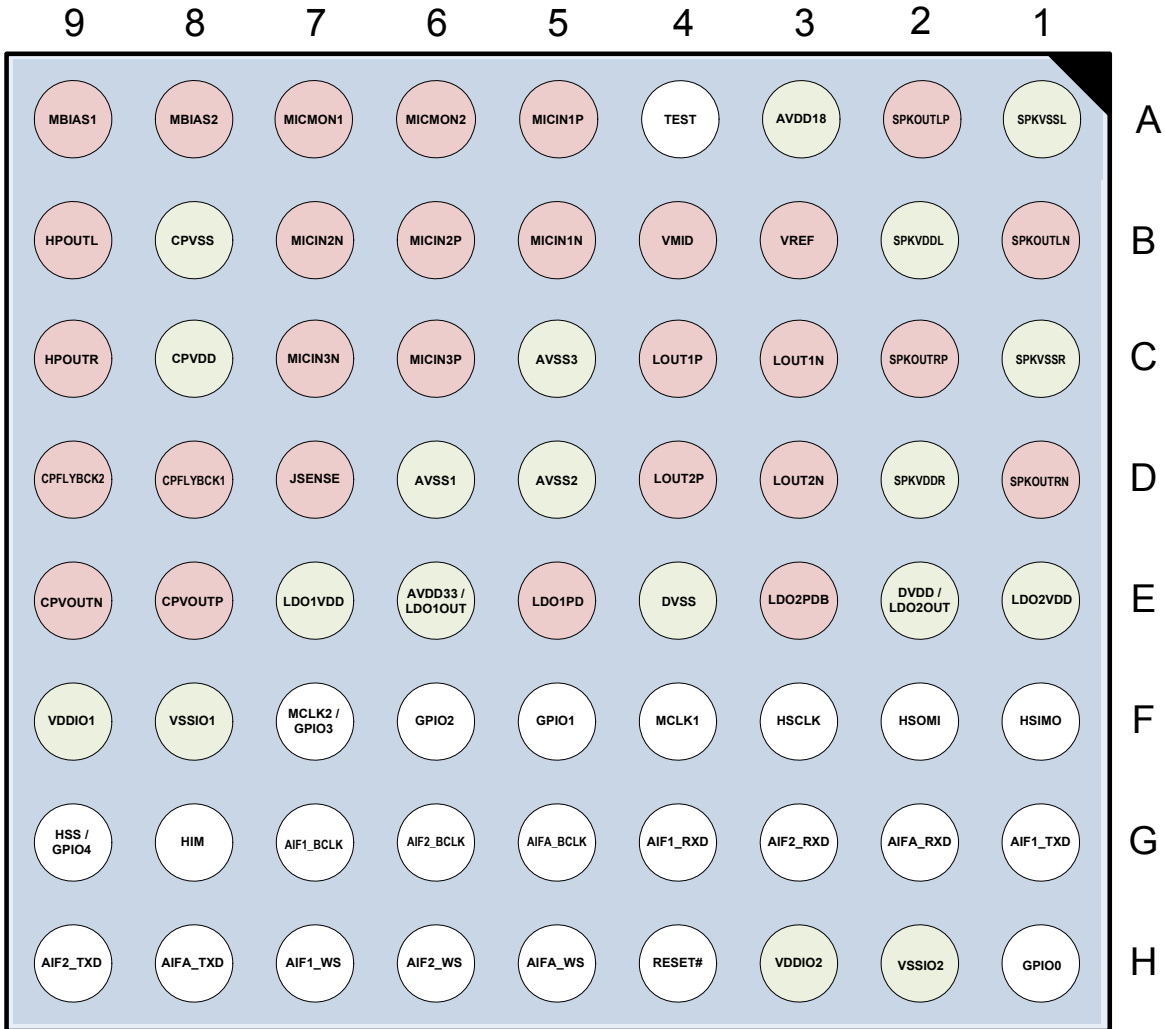


TERMINAL			INPUT/ OUTPUT/ POWER (I/O/P)	DESCRIPTION
NAME	BALL WLP	TYPE		
MBIAS1	A9	analog	O	Microphone Bias
MBIAS2	A8	analog	O	Microphone Bias
MICMON1	A7	analog	I	Microphone monitor input. Muxed – Headset Gnds/Mic
MICMON2	A6	analog	I	Microphone monitor input. Muxed – Headset Gnds/Mic
MICIN1P	A5	analog	I	Differential microphone & digital mic inputs. (MICIN2N =DMIC1D, MICIN3P=DMIC2D, MICIN3N=DMICCLK)
MICIN1N	B5	analog	I	Differential microphone & digital mic inputs. (MICIN2N =DMIC1D, MICIN3P=DMIC2D, MICIN3N=DMICCLK)
MICIN2P	B6	analog	I	Differential microphone & digital mic inputs. (MICIN2N =DMIC1D, MICIN3P=DMIC2D, MICIN3N=DMICCLK)
MICIN2N	B7	analog	I	Differential microphone & digital mic inputs. (MICIN2N =DMIC1D, MICIN3P=DMIC2D, MICIN3N=DMICCLK)
MICIN3P	C6	analog	I	Differential microphone & digital mic inputs. (MICIN2N =DMIC1D, MICIN3P=DMIC2D, MICIN3N=DMICCLK)
MICIN3N	C7	analog	I	Differential microphone & digital mic inputs. (MICIN2N =DMIC1D, MICIN3P=DMIC2D, MICIN3N=DMICCLK)
JSENSE	D7	analog	I	Jack Sense input.
HPOUTL	B9	analog	O	Capless Stereo Headphone Output.
HPOUTR	B8	analog	O	Capless Stereo Headphone Output.
SPKOUTLN	B1	analog	O	Stereo Differential Class D Speaker Output.
SPKOUTLP	A2	analog	O	Stereo Differential Class D Speaker Output.
SPKOUTRN	C2	analog	O	Stereo Differential Class D Speaker Output.
SPKOUTRP	D1	analog	O	Stereo Differential Class D Speaker Output.
SPKVDDL	B2	power	P	Speaker power
SPKVDDR	D2	power	P	Speaker power
SPKVSSL	A1	power	P	Speaker Ground
SPKVSSR	C1	power	P	Speaker Ground
LOUT1N	C3	analog	O	Differential Line outputs.
LOUT1P	C4	analog	O	Differential Line outputs.
LOUT2N	D3	analog	O	Differential Line outputs.
LOUT2P	D4	analog	O	Differential Line outputs.
LDO1VDD	E7	power	I	LDO input power
TERMINAL			INPUT/ OUTPUT/ POWER (I/O/P)	DESCRIPTION
NAME	BALL WLP	PIN QFN		
LDO2VDD	E1	power	I	LDO input power
LDO1PD	E5	analog	I	Power-dn. LDO1PD active high power down.
LDO2PDB	E3	analog	I	Power-dn. LDO2PDB is active low power down.
LDO1OUT	E6	power	I	3.0V, 0.95V power supplies. LDO1OUT = AVDD33,
LDO2OUT	E2	power	I	3.0V, 0.95V power supplies. LDO2OUT=DVDD
AVSS1	D6	power	I	Analog Ground.
AVSS2	D5	power	I	Analog Ground.
AVSS3	C5	power	I	Analog Ground.
DVSS	E4	power	I	Digital Ground. (route to VSS ball)
VMID	B4	analog	I/O	3.3V / 2 reference. (ext decouple)
VREF	B3	analog	I/O	Bandgap reference (ext decouple)

CPVDD	C8	analog	I/O	Charge-pump Supply
CPVSS	B8	analog	I/O	Charge-pump Supply
CPFLYBCK1	D8	analog	I/O	Flyback capacitor
CPFLYBCK2	D9	analog	I/O	Flyback capacitor
CPVOUTP	E8	analog	I/O	Charge-pump DC-DC supply.
CPVOUTN	E9	analog	I/O	Charge-pump DC-DC supply.
VDDIO1	F9	power	I	Pad Ring Pwr. GPIO/I2S/I2S-pass-thru, & I2S/CAB/Host/Ctrl
VDDIO2	H3	power	I	Pad Ring Pwr. GPIO/I2S/I2S-pass-thru, & I2S/CAB/Host/Ctrl
VSSIO1	F8	power	I	Pad Ring Gnd. 3.3V nominal. 3 sets for VSSIO.
VSSIO2	H2	power	I	Pad Ring Gnd. 3.3V nominal. 3 sets for VSSIO.
MCLK1	F4	pd_gpio	I	Master Reference Clocks for PLLs. (MCLK2 = GPIO[3])
MCLK2/GPIO3	F7	pd_gpio	I	Master Reference Clocks for PLLs. (MCLK2 = GPIO[3])
GPIO2	F6	pd_gpio	I/O	5-b General purpose I/O port.
GPIO1	F5	pd_gpio	I/O	5-b General purpose I/O port. MCLK2 and HSS are alternative general purpose I/O ports.
GPIO0	H1	pd_gpio	I/O	5-b General purpose I/O port. MCLK2 and HSS are alternative general purpose I/O ports.
HSCLK	F3	pd_gpio	I	Serial Clock (or SCL)
HSIMO	F1	pd_gpin	I	Serial Data input (alt_slave_id)
HSOMI	F2	pd_gpio	I/O	Slave Output (or SDA)

TERMINAL			INPUT/ OUTPUT/ POWER (I/O/P)	DESCRIPTION
NAME	BALL WCSP	TYPE		
LDO2VDD	E1	power	P	LDO input power
HSS/GPIO4	G9	pd_gpio	I/O	Slave select (or GPIO[4])
HIM	G8	pd_gpio	I	Host Interface Mode, 1 = SPI, 0 = I2C
AIF{1,2,A}_BCLK	G{8,6,5}	pd_gpio	I/O	I2S/PCM Bit Clock (AIF2_BCLK = C_CLK)
AIF{1,2,A}_RXD	G{4,3,2}	pd_gpin	I	Receive Data (AIF2_RXD = C_DI, AIF1_RXD=C_RST)
AIF{1,2,A}_TXD	G{1}, H{9,8}	pd_gpio	O	Transmit Data (AIF2_TXD = C_DO)
AIF{1,2,A}_WS	H{7,6,5}	pd_gpio	I/O	Receive/Transmit Word Select (AIF2_WS = C_FRM)

BOTTOM VIEW



ABSOLUTE MAXIMUM RATINGS⁽¹⁾

over operating free-air temperature range, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

	VALUE / UNIT
Supply voltage, AVDD, PVDD	- 0.3 V to 6.0 V
V_I Input Voltage	-0.3 V to $V_{DD} + 0.3$ V
T_A Operating free-air temperature range	-40 ? C to 85 ? C
T_J Operating junction temperature range	-40 ? C to 150 ? C
T_{stg} Storage temperature range	-65 ? C to 85 ? C
Lead temperature 1.6 mm (1/16 inch) from case for 10 seconds	260 ? C

ORDERING GUIDE

T_A	PACKAGED DEVICES	PART NUMBER	SYMBOL
-40°C to 85°C	72-ball, 4.0 mm × 3.9 mm WSCP	CX20787 xxx	TBD
	88-pin, TBD LGA	CX20787 xxx	TBD

Device Power Supplies

Parameter	Ball Name	MIN	TYP	MAX	UNIT
Digital Core Supply	LDO2OUT (DVDD)	0.95	1.0	1.98	V
3V Analog Supply	LDO1OUT (AVDD33)	2.24	3.0	3.3	V
Digital I/O Supply 1	VDDIO1	1.62	1.8	3.6	V
Digital I/O Supply 2	VDDIO2	1.62	1.8	3.6	V
1.8V Analog Supply	AVDD18	1.71	1.8	1.98	V
Charge Pump Supply	CPVDD	1.71	1.8	1.98	V
Left Speaker Supply	SPKVDDL	2.7	5.0	5.5	V
Right Speaker Supply	SPKVDDR	2.7	5.0	5.5	V
LDO1 Supply	LDO1VDD	2.7	5.0	5.5	V
LDO2 Supply	LDO2VDD	1.71	1.8	1.98	V

ELECTRICAL CHARACTERISTICS

T_A = 25°C (unless otherwise noted); AVDD18 = 1.8 V; AVDD33 = 3.3 V; SPKVDD = 5 V; DVDD = 1.0 V

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
I2S to Headphone Out	All Supplies at Min Value		4.7		mW
	All Supplies at Typical		7.5		mW
Standby Power	All Supplies at Min Value		70		μW
	All Supplies at Typical		106		μW
Record Power	All Supplies at Min Value		15.5		mW
	All Supplies at Typical		23		mW
Digital Bypass Power	All Supplies at Min Value		9.3		mW
	All Supplies at Typical		17.2		mW
Handset Voice Power (analog MIC)	All Supplies at Min Value		6.4		mW
Handset Voice Power (digital MIC)	All Supplies at Min Value		4.1		mW
Speaker Leakage Power	All Supplies at Min Value		1		μW
	All Supplies at Typical		3		μW
I2S to Class-D Out	All Supplies at Min Value		7.6		mW
	All Supplies at Typical		15.2		mW

OPERATING CHARACTERISTICS

T_A = 25°C (unless otherwise noted); AVDD18 = 1.8 V; AVDD33 = 3.3 V; SPKVDD = 5 V; DVDD = 1.0 V

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
MIC – HEADPHONE						
SNR	Signal-to-noise ratio ⁽¹⁾			97		dB
THD+N	Total harmonic distortion plus noise	P _O = 20 mW, f = 1 kHz		83		dB
		P _O = 5 mW, f = 1 kHz		83		dB
MIC – CLASS-D						
SNR	Signal-to-noise ratio ⁽¹⁾			85		dB
THD+N	Total harmonic distortion plus noise	P _O = 1.0 W, f = 1 kHz		65		dB
		P _O = 500 mW, f = 1 kHz		63		dB
LINE IN – HEADPHONE						
SNR	Signal-to-noise ratio ⁽¹⁾			97		dB
THD+N	Total harmonic distortion plus noise	P _O = 20 mW, f = 1 kHz		85		dB
		P _O = 5 mW, f = 1 kHz		83		dB
	Crosstalk	(-20 dB, 10 kHz)		90		dB
LINE IN – CLASS-D						
SNR	Signal-to-noise ratio ⁽¹⁾			91		dB
THD+N	Total harmonic distortion plus noise	P _O = 1.0 W, f = 1 kHz		65		dB
		P _O = 500 mW, f = 1 kHz		63		dB
LINE IN – ADC						
SNR	Signal-to-noise ratio ⁽¹⁾			92		dB
THD+N	Total harmonic distortion plus noise	-1 dBFS input		85		dB
		-1 dBFS input		83		dB
	Crosstalk			90		dB
DAC – ADC						
SNR	Signal-to-noise ratio ⁽¹⁾			92		dB
THD+N	Total harmonic distortion plus noise	-1 dBFS input		85		dB
		-1 dBFS input		90		dB
DAC – SE LINEOUT						
SNR	Signal-to-noise ratio ⁽¹⁾			97		dB
THD+N	Total harmonic distortion plus noise	-1 dBFS input		75		dB
	Crosstalk			85		dB
DAC – DIFF LINEOUT						
SNR	Signal-to-noise ratio ⁽¹⁾			97		dB
THD+N	Total harmonic distortion plus noise	-1 dBFS input		85		dB
	Crosstalk			90		dB
DAC – HEADPHONE						
SNR	Signal-to-noise ratio ⁽¹⁾			97		dB
THD+N	Total harmonic distortion plus noise	R _{hp} = 16 Ω P _O = 20 mW, f = 1 kHz		85		dB
		R _{hp} = 16 Ω P _O = 5 mW, f = 1 kHz		83		dB
		R _{hp} = 32 Ω P _O = 20 mW, f = 1 kHz		83		dB
		R _{hp} = 32 Ω P _O = 5 mW, f = 1 kHz		81		dB
	Crosstalk			90		dB
DAC – CLASS-D						
SNR	Signal-to-noise ratio ⁽¹⁾			94		dB
THD+N	Total harmonic distortion plus noise	P _O = 1.0 W, f = 1 kHz		68		dB
		P _O = 500 mW, f = 1 kHz		63		dB
	Crosstalk			80		dB

(1) A-weighted